VAOL-S2RP4

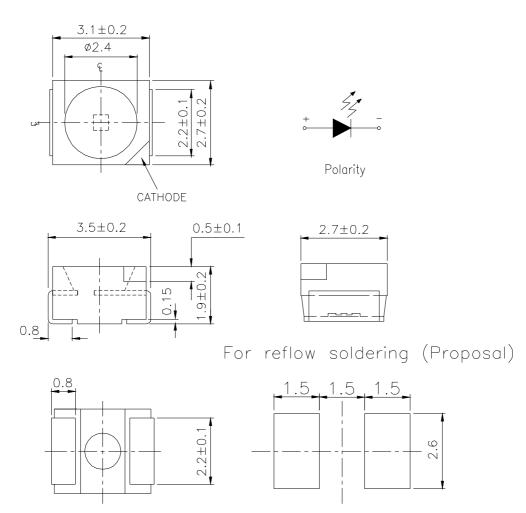
Features

- Fit automatic placement equipment.
- Fit Compatible with vapor-phase reflow, Infrared reflow and wave solder processes.
- White package.
- Pb-free.
- RoHS compliant.

Descriptions

- For higher packing density.
- For minature applications.
- Water clear lens .
- Chip material : AlGaInP .
- Emitting color: Red.

Package Outline Dimensions



Note: The tolerances unless mentioned is ± 0.1 mm, Unit = mm







Absolute Maximum Ratings (Ta=25°C)

8 7					
Parameter	Symbol	Rating	Units		
Reverse Voltage	VR	5	V		
Forward Current	IF	50	mA		
Operating Temperature	Topr	-40 ~ +85	$^{\circ}\!\mathbb{C}$		
Storage Temperature	Tstg	-40 ~ +100	$^{\circ}\!\mathbb{C}$		
Electrostatic Discharge(HBM)	ESD	2000	V		
Power Dissipation	Pd	120	mW		
Peak Forward Current (Duty 1/10 @1KHz)	IFP	100	mA		
Soldering Temperature	Tsol	Reflow Soldering: 260 °C for 10 sec. Hand Soldering: 350 °C for 3 sec.			

Electro-Optical Characteristics (Ta=25°C)

Parameter	Symbol	Min.	Тур.	M ax.	Unit	Condition
Luminous intensity	IV	360		900	mcd	IF=20mA
Viewing Angle	2 <i>θ</i> 1/2		120		deg	IF=20mA
Peak Wavelength	λр		624		nm	IF=20mA
Dominant Wavelength	λd	621		631	nm	IF=20mA
Spectrum Radiation Bandwidth	Δλ		20		nm	IF=20mA
Forward Voltage	VF	1.75		2.35	V	IF=20mA
Reverse Current	IR			10	μΑ	VR=5V

Notes:

- 1. Tolerance of Luminous Intensity ±10%
- 2. Tolerance of Dominant Wavelength \pm 1nm
- 3. Tolerance of Forward Voltage ±0.1V







Bin Range Of Dominant Wavelength

Group	Bin Code	Min.	Max.	Unit	Condition
$F = \frac{FF1}{FF2}$	FF1	621	626	nm	I _F =20mA
	FF2	626	631		

Bin Rang Of Luminous Intensity

	v			
Bin	Min	Max	Unit	Condition
T2	360	450		IF=20mA
U1	450	565	•	
U2	565	715	mcd	
V1	715	900		

Bin Rang Of Forward Voltage

Group	Bin	Min	Max	Unit	Condition
B 0 1 2	0	1.75	1.95	V	IF=20mA
	1	1.95	2.15		
	2	2.15	2.35		

Notes:

1.Tolerance of Luminous Intensity ±10%

2. Tolerance of Dominant Wavelength \pm 1nm

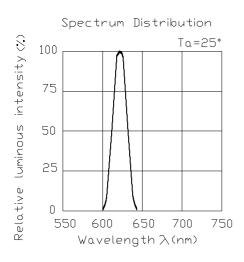
3.Tolerance of Forward Voltage ±0.1V

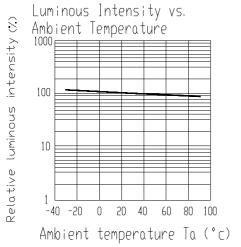


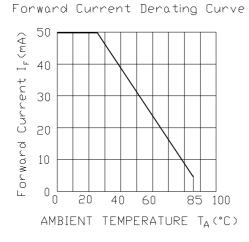


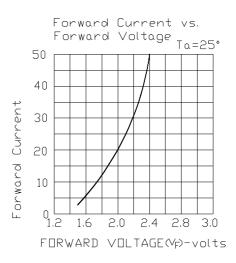


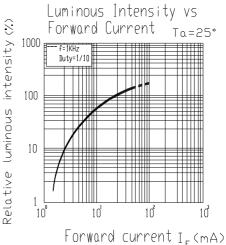
Typical Electro-Optical Characteristics Curves

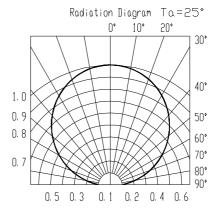








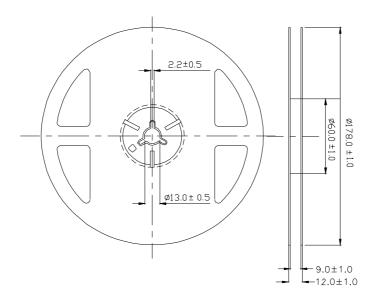








Reel Dimensions

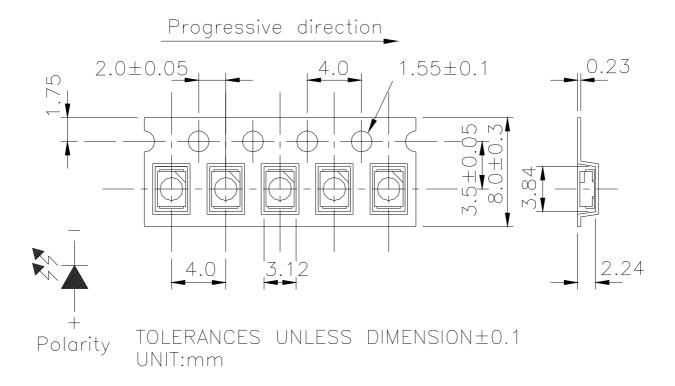


Note: The tolerances unless mentioned is ± 0.1 mm, Unit = mm



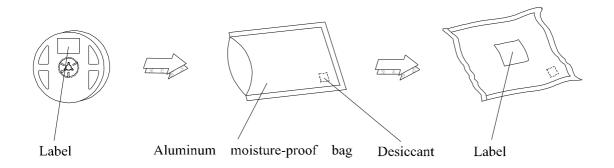


Carrier Tape Dimensions: Loaded quantity 2000 PCS per reel.



Note: The tolerances unless mentioned is ± 0.1 mm Unit = mm

Moisture Resistant Packaging

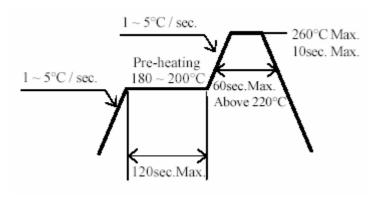






Soldering Condition

1.Pb-free solder temperature profile



- 2.Reflow soldering should not be done more than two times.
- 3 When soldering, do not put stress on the LEDs during heating.
- 4 After soldering, do not warp the circuit board.

Soldering Iron

Each terminal is to go to the tip of soldering iron temperature less than 350°C for 3 seconds within once in less than the soldering iron capacity 25W. Leave two seconds and more intervals, and do soldering of each terminal. Be careful because the damage of the product is often started at the time of the hand solder.





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